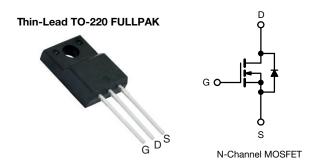
RoHS

COMPLIANT HALOGEN

FREE



EF Series Power MOSFET with Fast Body Diode



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	650)
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	0.176
Q _g max. (nC)	84	
Q _{gs} (nC)	14	
Q _{gd} (nC)	24	
Configuration	Sing	le

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters) • Switch mode power suppliers (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA21N60EF-E3
Lead (Pb)-free and halogen-free	SiHA21N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	V
Continuous drain surrent /T 150 °C)	\/ at 10 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		9	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	Α
Pulsed drain current ^a			I _{DM}	53	
Linear derating factor				0.28	W/°C
Single pulse avalanche energy b			E _{AS}	367	mJ
Maximum power dissipation			P_{D}	35	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		-11//-14	70	V/ns
Reverse diode dV/dt ^d			dV/dt	50	V/IIS
Soldering recommendations (peak temperature) c	for '	10 s		300	°C
Mounting torque	M3 s	crew		0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature b. $V_{DD}=50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A
- 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 900 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.6	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		^			•	·	
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Cata assumas laskana	1	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zero gate voltage drain current	looo		= 480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 \	$V_{\rm S} = 0 \ V_{\rm T} = 125 \ ^{\circ}{\rm C}$	-	-	500	μΑ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.153	0.176	Ω
Forward transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 11 A	-	7	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	2030	-	
Output capacitance	C _{oss}		$V_{DS} = 100 V,$		105	-	
Reverse transfer capacitance	C_{rss}		f = 1 MHz	-	5	-	1
Effective output capacitance, energy related ^a	$C_{\text{o(er)}}$	V _{GS} = 0 V, V _{DS} = 0 V to 480 V		-	86	-	pF -
Effective output capacitance, time related ^b	$C_{o(tr)}$			-	299	-	
Total gate charge	Qg			-	56	84	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 11 A, V_{DS} = 480 V$	-	14	-	nC
Gate-drain charge	Q _{gd}			-	24	-	
Turn-on delay time	t _{d(on)}			-	21	42	
Rise time	t _r	V _{DD} = 480 V, I _D = 11 A		-	31	62	ns
Turn-off delay time	t _{d(off)}	$R_g = 1$	$R_g = 9.1 \Omega, V_{GS} = 10 V$		59	89	
Fall time	t _f	1		-	27	54	
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.56	1.2	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	
Pulsed diode forward current	I _{SM}			-	-	53	A
Diode forward voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		0.9	1.2	V
Reverse recovery time	t _{rr}			-	135	270	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 11 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 400 \text{ V}$		_	0.76	1.52	μC
Reverse recovery current	I _{RRM}			-	11	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

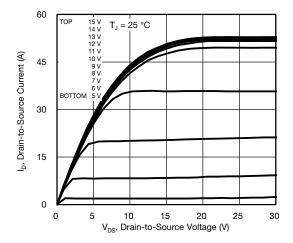


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

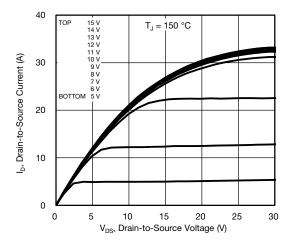


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

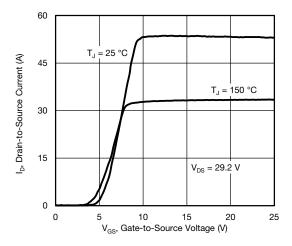


Fig. 3 - Typical Transfer Characteristics

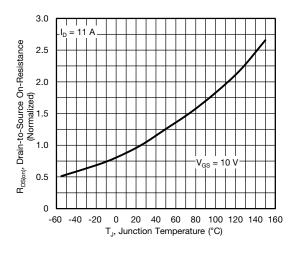


Fig. 4 - Normalized On-Resistance vs. Temperature

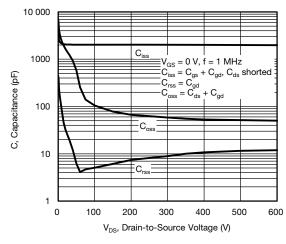


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

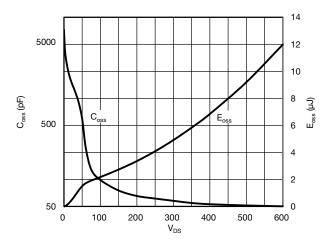


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



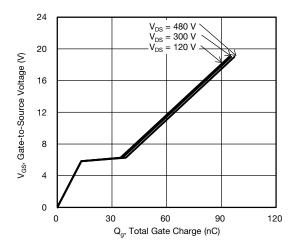


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

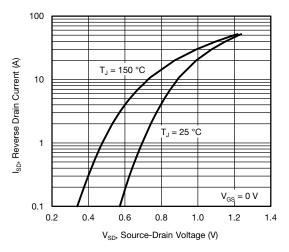


Fig. 8 - Typical Source-Drain Diode Forward Voltage

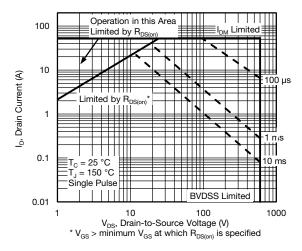


Fig. 9 - Maximum Safe Operating Area

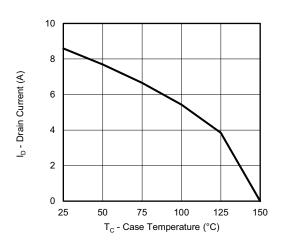


Fig. 10 - Maximum Drain Current vs. Case Temperature

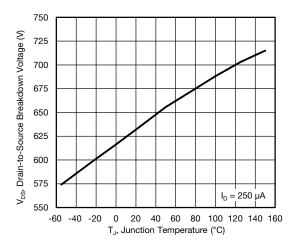


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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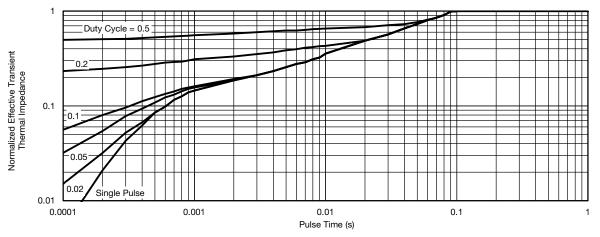


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

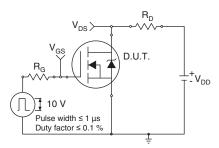


Fig. 13 - Switching Time Test Circuit

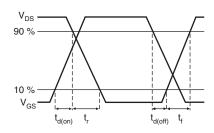


Fig. 14 - Switching Time Waveforms

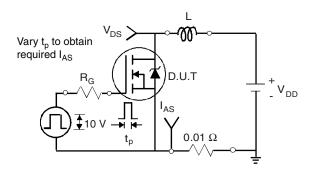


Fig. 15 - Unclamped Inductive Test Circuit

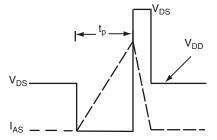


Fig. 16 - Unclamped Inductive Waveforms

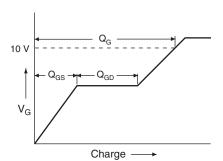


Fig. 17 - Basic Gate Charge Waveform

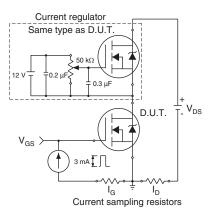
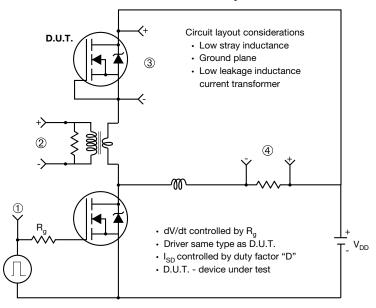


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



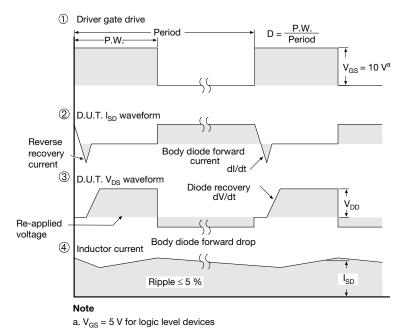
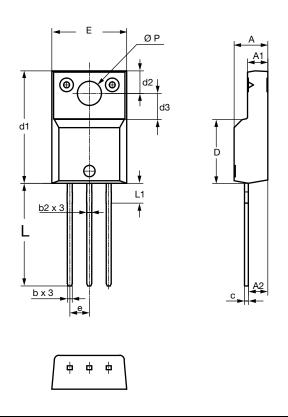


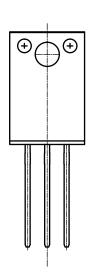
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	IETERS	INCH	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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